



SamHop Microelectronics Corp.



STU/D616S

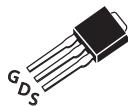
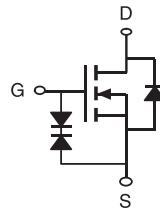
Ver1.1

N-Channel Logic Level Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V _{DSS}	I _D	R _{DSON} (mΩ) Typ
60V	16A	64 @ V _{GS} =10V
		81 @ V _{GS} =4.5V

FEATURES

- Super high dense cell design for low R_{DSON}.
- Rugged and reliable.
- Surface Mount Package.
- ESD Protected.

STU SERIES
TO-252AA(D-PAK)STD SERIES
TO-251(I-PAK)

ABSOLUTE MAXIMUM RATINGS (T_C=25°C unless otherwise noted)

Symbol	Parameter	Limit	Units
V _{DS}	Drain-Source Voltage	60	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current-Continuous ^a	16	A
I _{DM}	-Pulsed ^b	46.8	A
I _{AS}	Avalanche Current ^c	9	A
E _{AS}	Avalanche Energy ^c	20.25	mJ
P _D	Maximum Power Dissipation ^a	60	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 175	°C

THERMAL CHARACTERISTICS

R _θ JC	Thermal Resistance, Junction-to-Case	2.5	°C/W
R _θ JA	Thermal Resistance, Junction-to-Ambient	50	°C/W

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ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	60			V
BV_{DSS}	Drain-Source Breakdown Voltage ^a	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=10\text{mA}$	65			V
$I_{\text{DS}}^{\text{SS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=48\text{V}$, $V_{\text{GS}}=0\text{V}$			1	A
I_{GSS}	Gate-Body leakage current	$V_{\text{GS}}= \pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$			± 10	μA
ON CHARACTERISTICS ^a						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	1	1.8	3	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=8\text{A}$		64	77	m ohm
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=6\text{A}$		81	99	m ohm
g_{FS}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{D}}=8\text{A}$		13.5		S
DYNAMIC CHARACTERISTICS ^b						
C_{iss}	Input Capacitance	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$		780		pF
C_{oss}	Output Capacitance			58.5		pF
C_{rss}	Reverse Transfer Capacitance			46.5		pF
SWITCHING CHARACTERISTICS ^b						
$t_{\text{D}(\text{ON})}$	Turn-On DelayTime	$V_{\text{DD}}=30\text{V}$ $I_{\text{D}}=1\text{A}$ $V_{\text{GS}}=10\text{V}$ $R_{\text{GEN}}= 6 \text{ ohm}$		14		ns
t_r	Rise Time			13		ns
$t_{\text{D}(\text{OFF})}$	Turn-Off DelayTime			38		ns
t_f	Fall Time			9.4		ns
Q_g	Total Gate Charge	$V_{\text{DS}}=30\text{V}, I_{\text{D}}=8\text{A}, V_{\text{GS}}=10\text{V}$		13.5		nC
		$V_{\text{DS}}=30\text{V}, I_{\text{D}}=8\text{A}, V_{\text{GS}}=4.5\text{V}$		6.7		nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=30\text{V}, I_{\text{D}}=8\text{A}$ $V_{\text{GS}}=10\text{V}$		1.88		nC
Q_{gd}	Gate-Drain Charge			3.71		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I_{S}	Maximum Continuous Drain-Source Diode Forward Current				1.5	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=1.5\text{A}$		0.8	1.3	V
Notes						
a.Pulse Test:Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.						
b.Guaranteed by design, not subject to production testing.						
c.Starting $T_j=25^\circ\text{C}$, $L=0.5\text{mH}$, $R_g=25\Omega$, $I_{\text{AS}}=9\text{A}$, $V_{\text{DD}} \leq V_{(\text{BR})\text{DSS}}$. (See Figure13)						
e.Pulse Test : Pulse Width $< 1\mu\text{s}$, Duty Cycle $< 1\%$.						

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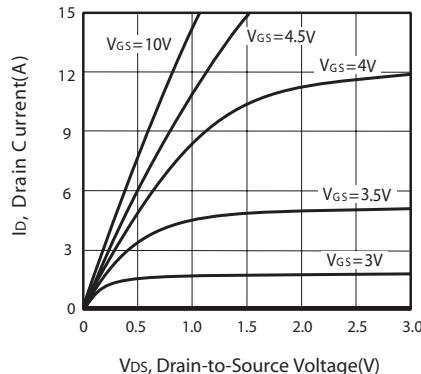


Figure 1. Output Characteristics

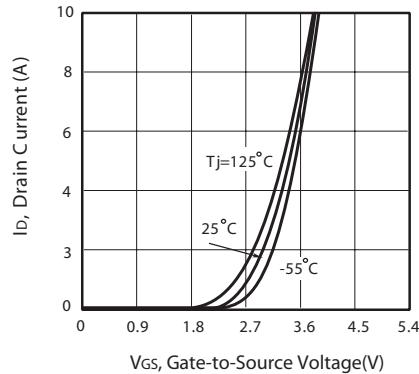


Figure 2. Transfer Characteristics

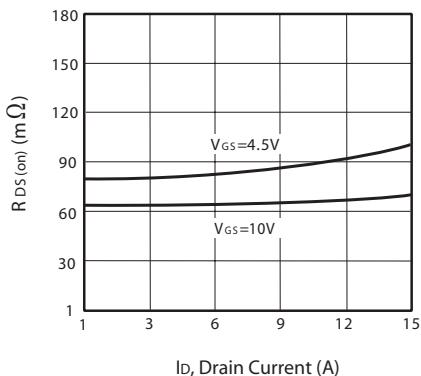


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

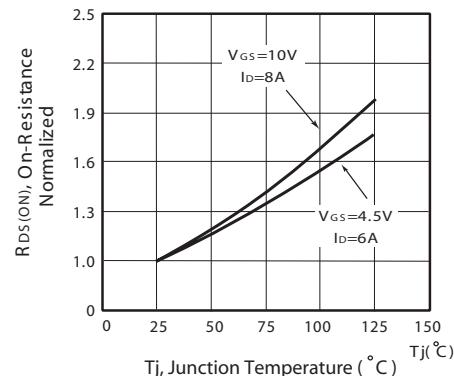


Figure 4. On-Resistance Variation with Drain Current and Temperature

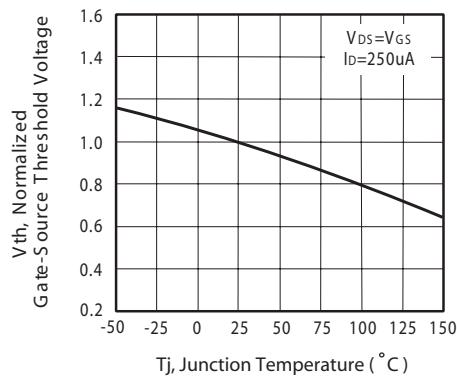


Figure 5. Gate Threshold Variation with Temperature

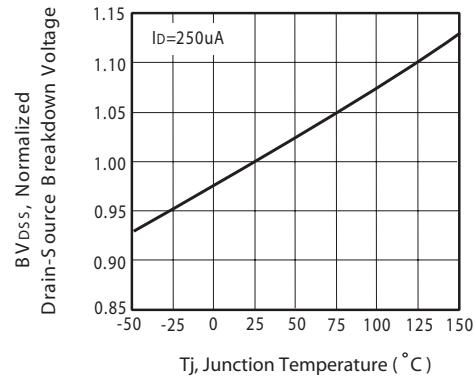


Figure 6. Breakdown Voltage Variation with Temperature

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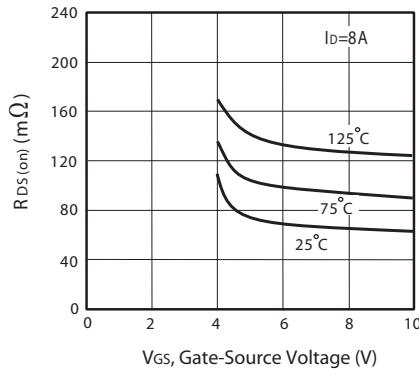


Figure 7. On-Resistance vs.
Gate-Source Voltage

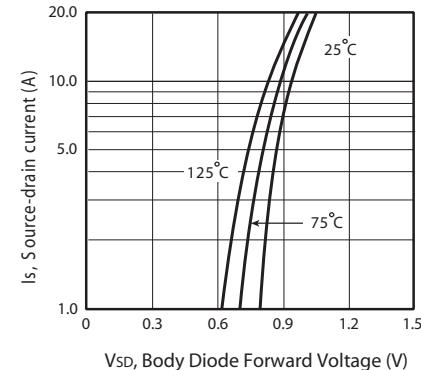


Figure 8. Body Diode Forward Voltage
Variation with Source Current

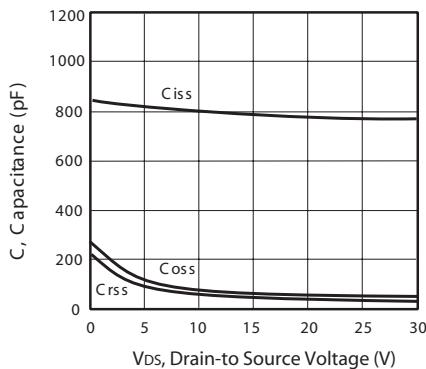


Figure 9. Capacitance

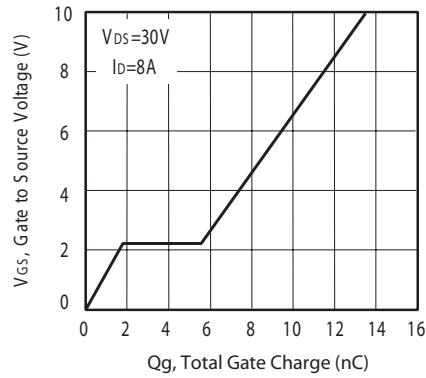


Figure 10. Gate Charge

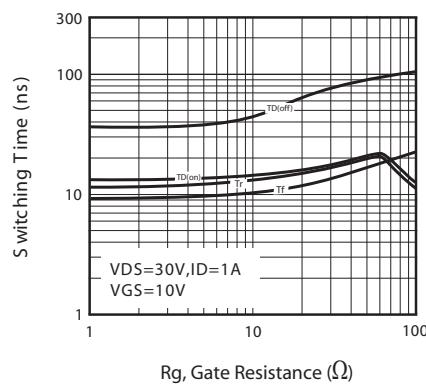


Figure 11. Switching Characteristics

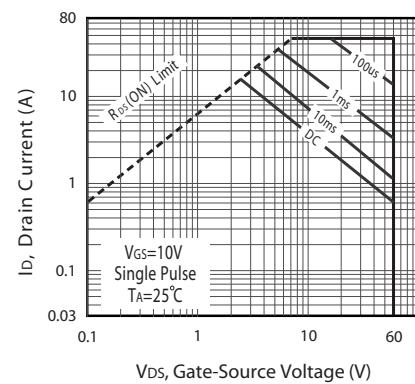
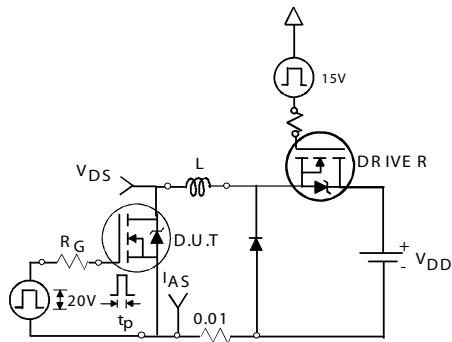


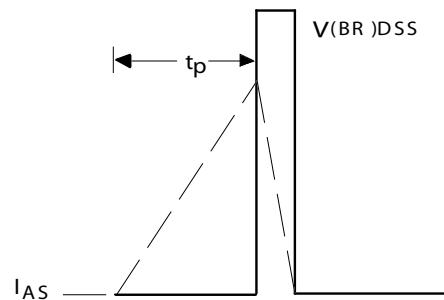
Figure 12. Maximum Safe
Operating Area

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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

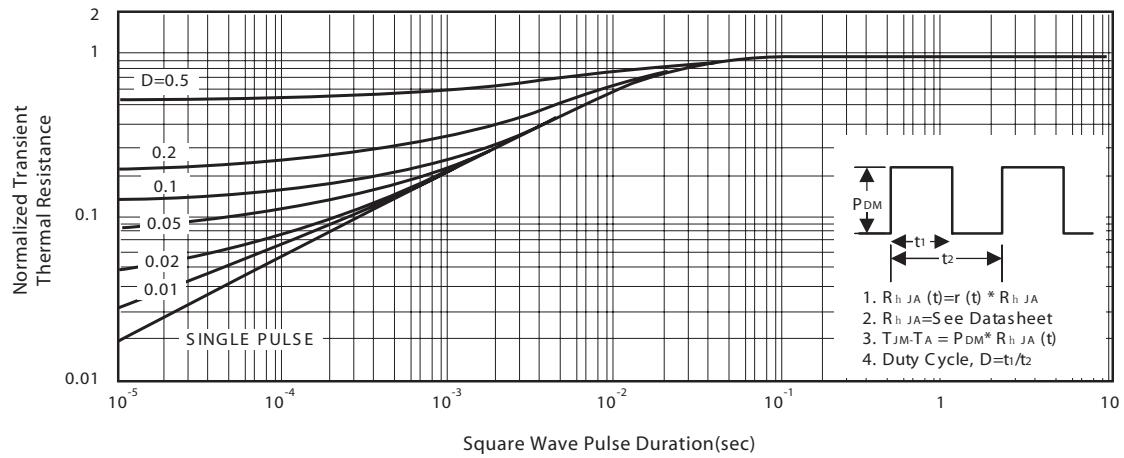
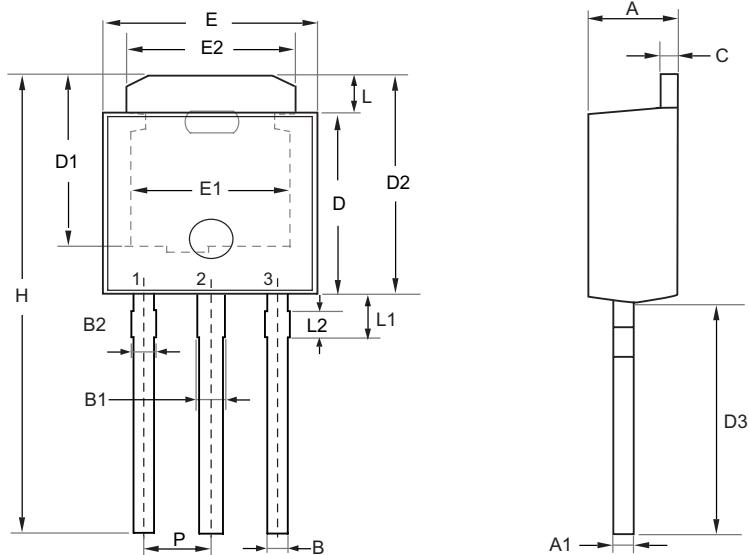


Figure 14. Normalized Thermal Transient Impedance Curve

PACKAGE OUTLINE DIMENSIONS

TO-251

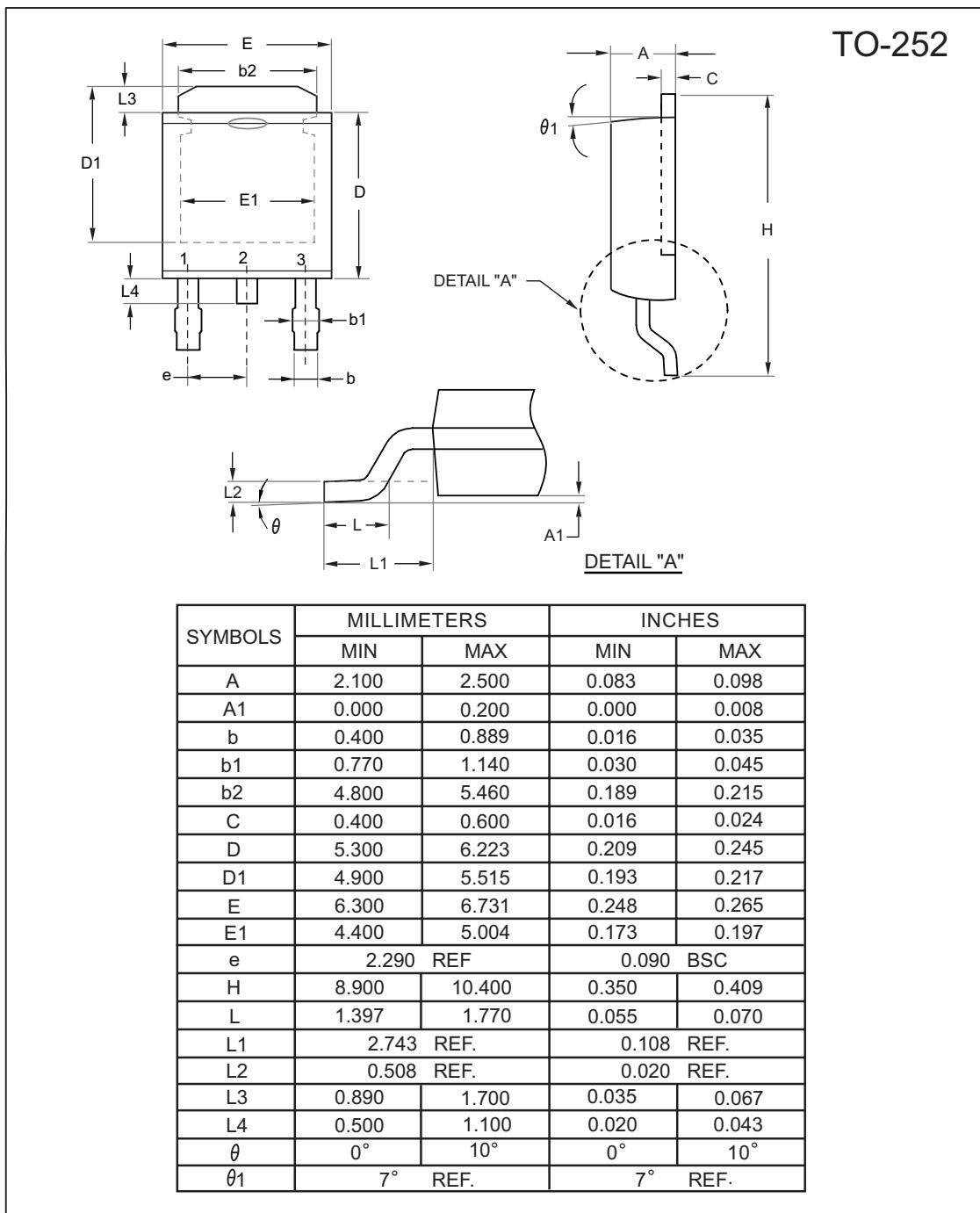


SYMBOL	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.100	2.500	0.083	0.098
A1	0.350	0.650	0.014	0.026
B	0.400	0.800	0.016	0.031
B1	0.650	1.050	0.026	0.041
B2	0.500	0.900	0.020	0.035
C	0.400	0.600	0.016	0.024
D	5.300	5.700	0.209	0.224
D1	4.900	5.300	0.193	0.209
D2	6.700	7.300	0.264	0.287
D3	7.000	8.000	0.276	0.315
H	13.700	15.300	0.539	0.602
E	6.300	6.700	0.248	0.264
E1	4.600	4.900	0.181	0.193
E2	4.800	5.200	0.189	0.205
L	1.300	1.700	0.051	0.067
L1	1.400	1.800	0.055	0.071
L2	0.500	0.900	0.020	0.035
P	2.300 BSC		0.091 BSC	

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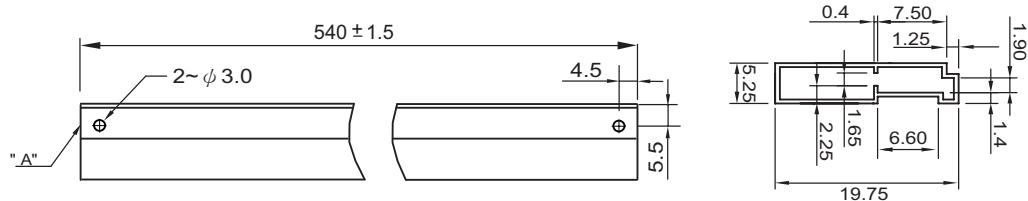
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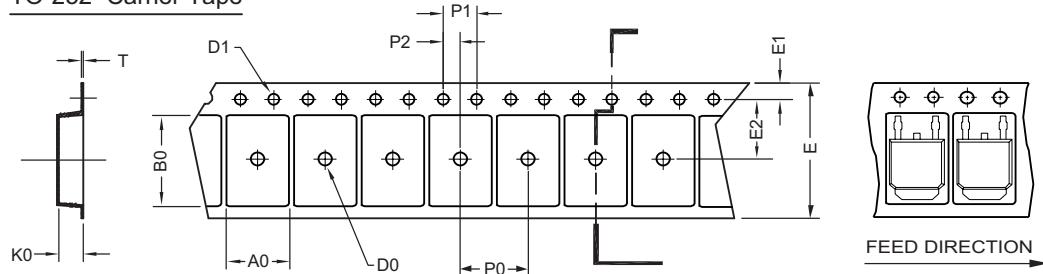
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TO251 Tube/TO-252 Tape and Reel Data

TO-251 Tube



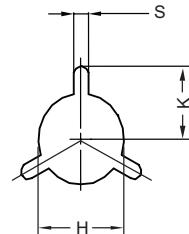
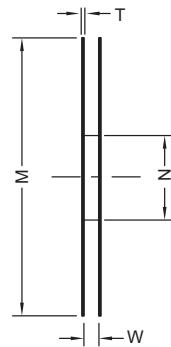
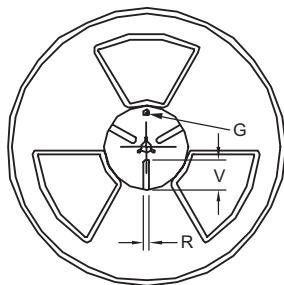
TO-252 Carrier Tape



UNIT:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
TO-252 (16 mm)	6.96 ±0.1	10.49 ±0.1	2.79 ±0.1	ψ 2	ψ 1.5 + 0.1 - 0	16.0 ±0.3	1.75 ±0.1	7.5 ±0.15	8.0 ±0.1	4.0 ±0.1	2.0 ±0.15	0.3 ±0.05

TO-252 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	T	H	K	S	G	R	V
16 mm	ψ 330	ψ 330 ± 0.5	ψ 97 ± 1.0	17.0 + 1.5 - 0	2.2	ψ 13.0 + 0.5 - 0.2	10.6	2.0 ± 0.5	---	---	---

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